

1N6309BD2A TO 1N6340BD2A

- DLCC2 Hermetic Ceramic Package Designed as a Drop-In Replacement for "D-5A"/"A-MELF" Package
- Standard Zener Voltage Tolerance of $\pm 5\%$
- Space Level and High-Reliability Screening Options Available



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise stated)

V_{ZM}	Reference Voltage	See Reference Table
I_{ZM}	Continuous DC Current	See Reference Table
P_T	Total Power Dissipation at $T_A = 75^\circ\text{C}$	500mW
T_J	Junction Temperature Range	-65 to +175°C
T_{STG}	Storage Temperature Range	-65 to +175°C
T_{SP}	Maximum Soldering Pad Temperature for 20s	260°C

THERMAL PROPERTIES

Symbol	Parameter	Max	Units
$R_{\theta JA}^{(1)}$	Thermal Resistance Junction to Ambient	300	$^\circ\text{C/W}$

(1) PCB = FR4 – 0.0625 Inch (1.59mm), 1 Layer, 1.0-Oz Cu, 0.007 Inch² (1.7mm x 2.76mm²) Pad Size, horizontal, in still air

500mW ZENER DIODES 1N6309BD2A TO 1N6340BD2A

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise stated)

Type	Nominal Zener Voltage @ I_{Z2} (V_{Z2})	Minimum Zener Voltage @ I_{Z1} 250 μA (V_{Z1})	Test Current (I_{Z2})	Max Zener Impedance		I_{ZM}	Voltage Reg. ⁽²⁾ $V_{Z(\text{reg})}$	Surge Current (I_{ZSM})	V_R	Maximum Reverse Current @ V_R		Maximum Noise Density N_D	Typical ⁽³⁾ Temp Coefficient α_{VZ}
				@ I_{Z2} (Z_Z)	@ 250 μA (Z_{ZK})					@25 $^\circ\text{C}$ I_{R1}	@150 $^\circ\text{C}$ I_{R2}		
Volts		Volts	mA	Ω		mA	V	A	V	μA		$\mu\text{V}/\text{Hz}$	%/ $^\circ\text{C}$
1N6309	2.4	1.1	20	30	1200	177	1.5	2.5	1.0	100	200	1.0	-0.085
1N6310	2.7	1.2	20	30	1300	157	1.5	2.2	1.0	60	150	1.0	-0.080
1N6311	3.0	1.3	20	29	1400	141	1.5	2	1.0	30	100	1.0	-0.075
1N6312	3.3	1.5	20	27	1400	128	1.6	1.8	1.0	5	20	1.0	-0.070
1N6313	3.6	1.8	20	25	1400	117	1.6	1.65	1.0	3	12	1.0	-0.065
1N6314	3.9	2	20	23	1700	108	1.6	1.5	1.0	2	12	1.0	-0.060
1N6315	4.3	2.4	20	20	1700	99	0.9	1.4	1.0	2	12	1.0	-0.045 +0.020
1N6316	4.7	2.8	20	17	1500	90	0.5	1.27	1.5	5	12	1.0	-0.028 +0.032
1N6317	5.1	3.3	20	14	1300	83	0.4	1.17	2	5	12	1.0	-0.020 +0.035
1N6318	5.6	4.3	20	8	1200	76	0.4	1.1	2.5	5	10	2	+0.050
1N6319	6.2	5.2	20	3	800	68	0.3	0.97	3.5	5	10	5	+0.060
1N6320	6.8	6.0	20	3	400	63	0.35	1.23	4	2	50	5	+0.062
1N6321	7.5	6.6	20	4	400	57	0.4	1.16	5	2	30	5	+0.068
1N6322	8.2	7.5	20	5	400	52	0.4	1.07	6	1.0	10	20	+0.075
1N6323	9.1	8.4	20	6	500	47	0.5	0.97	7	1.0	10	40	+0.076
1N6324	10	9.1	20	6	500	43	0.5	0.89	8	1.0	10	80	+0.079
1N6325	11	10	20	7	550	39	0.5	0.83	8.5	1.0	10	100	+0.082
1N6326	12	11	20	7	550	35	0.55	0.77	9	1.0	10	100	+0.083
1N6327	13	11.9	9.5	8	550	33	0.55	0.71	9.9	0.05	10	100	+0.083
1N6328	15	13.8	8.5	10	600	28	0.7	0.62	11	0.05	10	100	+0.084
1N6329	16	14.7	7.8	12	600	27	0.75	0.58	12	0.05	10	100	+0.084
1N6330	18	16.6	7	14	600	24	0.85	0.52	14	0.05	10	100	+0.085
1N6331	20	18.5	6.2	18	500	21	0.95	0.47	15	0.05	10	100	+0.086
1N6332	22	20.4	5.6	20	500	19	1.05	0.43	17	0.05	10	100	+0.087
1N6333	24	22.3	5.2	24	500	18	1.15	0.39	18	0.05	10	100	+0.088
1N6334	27	25.2	4.6	27	500	16	1.3	0.35	21	0.05	10	100	+0.090
1N6335	30	28	4.2	32	500	14	1.45	0.31	23	0.05	10	100	+0.091
1N6336	33	30.9	3.8	40	600	13	1.6	0.28	25	0.05	10	100	+0.092
1N6337	36	33.7	3.4	50	600	12	1.75	0.26	27	0.05	10	100	+0.093
1N6338	39	36.6	3.2	55	700	11	1.9	0.24	30	0.05	10	100	+0.094
1N6339	43	40.4	3	65	800	9.9	2.1	0.22	33	0.05	10	80	+0.095
1N6340	47	44.2	2.7	75	900	9	2.25	0.2	36	0.05	10	80	+0.095

SERIES ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise)

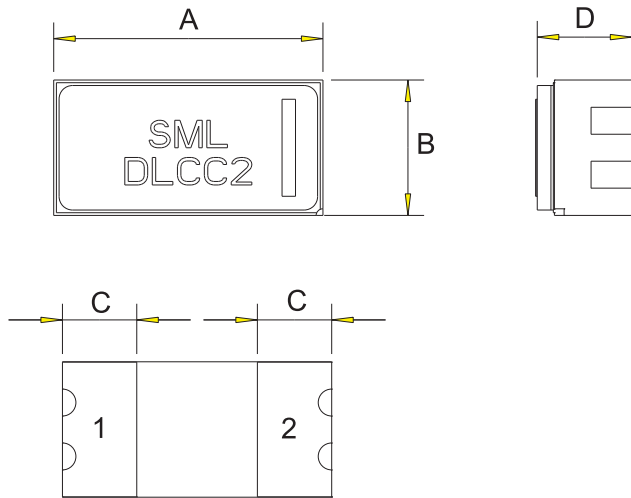
Symbol	Parameters	Test Conditions	Max	Units
V_F	Forward Voltage	$I_F = 200\text{mA}$	1.5	V

Note

- (2) Voltage regulation $V_{Z(\text{reg})}$ is the measured voltage change at thermal equilibrium between the current of 10% and 50% of Maximum Zener current I_{ZM} when the pad temperature is maintained at $25^\circ\text{C} \pm 8^\circ\text{C}$, -2°C . Not a production test.
- (3) Temp Coefficient is applicable to space product - I_Z stabilised at = I_{Z2} rated, $T_1 = +25^\circ\text{C} \pm 5^\circ\text{C}$; $T_2 = +125^\circ\text{C}$

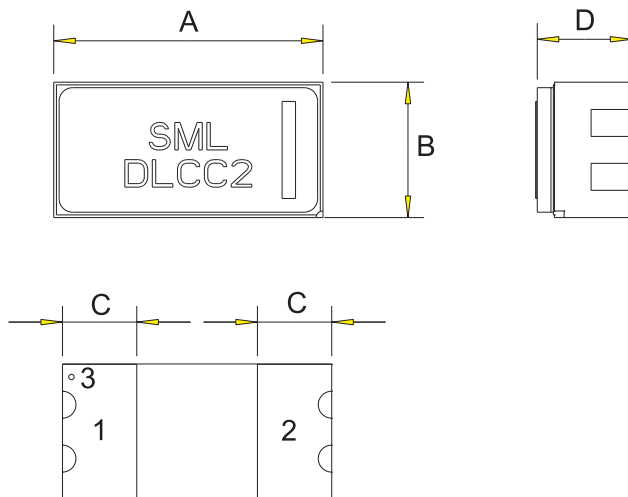
500mW ZENER DIODES 1N6309BD2A TO 1N6340BD2A

MECHANICAL DATA



DLCC2 Variant A (D2A)

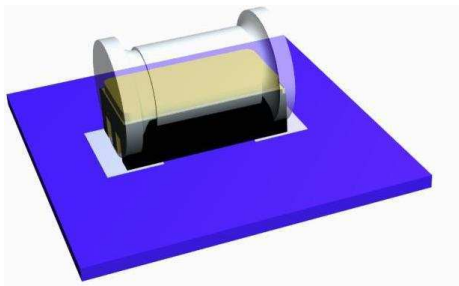
PAD 1	ANODE	
PAD 2	CATHODE	
DIMENSION	mm	Inches
A	5.00 ±0.10	0.197 ±0.004
B	2.61 ±0.10	0.103 ±0.004
C	1.08 ±0.10	0.043 ±0.004
D	1.76 ±0.10	0.069 ±0.004



DLCC2 Variant B (D2B)

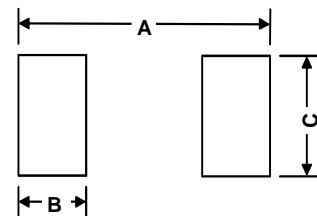
PAD 1	ANODE	
PAD 2	CATHODE	
PAD 3	LID CONTACT TO ANODE*	
DIMENSION	mm	Inches
A	5.00 ±0.10	0.197 ±0.004
B	2.61 ±0.10	0.103 ±0.004
C	1.08 ±0.10	0.043 ±0.004
D	1.76 ±0.10	0.069 ±0.004

DLCC2/ D-5A MELF OVERLAY



SOLDER PAD LAYOUT D-5A

DIMENSION	mm	Inches
A	6.25	0.246
B	1.70	0.067
C	2.67	0.105



* The additional contact provides a connection to the lid in the application. Connecting the metal lid to a known electrical potential stops deep dielectric discharge in space applications; see the Space Weather link www.semelab.co.uk/dlcc2.html on the Semelab web site. Package variant to be specified at order.

Other Package Outlines may be available – Contact Semelab Sales to Enquire

500mW ZENER DIODES 1N6309BD2A TO 1N6340BD2A

SCREENING OPTIONS

Space Level (JQRS/ESA) and High Reliability options are available in accordance with the [High Reliability and Screening Options Handbook](#) available for download from the from the TT electronics Semelab web site.

ESA Quality Level Products are based on the testing procedures specified in the generic ESCC 5000 and in the corresponding part detail specifications.

Semelabs QR216 and QR217 processing specifications (JQRS), in conjunction with the companies ISO 9001:2000 approval present a viable alternative to the American MIL-PRF-19500 space level processing.

QR217 (Space Level Quality Conformance) is based on the quality conformance inspection requirements of MIL-PRF-19500 groups A (table V), B (table VIa), C (table VII) and also ESA / ESCC 5000 (chart F4) lot validation tests.

QR216 (Space Level Screening) is based on the screening requirements of MIL-PRF-19500 (table IV) and also ESA /ESCC 5000 (chart F3).

JQRS parts are processed to the device data sheet and screened to QR216 with conformance testing to Q217 groups A and B in accordance with MIL-STD-750 methods and procedures.

Additional conformance options are available, for example Pre-Cap Visual Inspection, Buy-Off Visit or Data Packs. These are chargeable and must be specified at the order stage (See Ordering Information). Minimum order quantities may apply.

Alternative or additional customer specific conformance or screening requirements would be considered. Contact Semelab sales with enquiries.

MARKING DETAILS

Parts can be laser marked with approximately 7 characters on two lines and always includes cathode identification. Typical marking would include part or specification number, week of seal or serial number subject to available space and legibility.

Customer specific marking requirements can be arranged at the time of order.

Example Marking:



ORDERING INFORMATION

Part numbers are built up from Type, Package Variant, and screening level. The part numbers are extended to include the additional options as shown below.

Type – See Electrical Characteristics Table
Package Variant – See Mechanical Data
Screening Level – See Screening Options (ESA / JQRS)

Additional Options:

Customer Pre-Cap Visual Inspection	.CVP
Customer Buy-Off visit	.CVB
Data Pack	.DA
Solderability Samples	.SS
Scanning Electron Microscopy	.SEM
Radiography (X-ray)	.XRAY
Total Dose Radiation Test	.RAD
MIL-PRF-19500 (QR217)	
Group B charge	.GRPB
Group B destructive mechanical samples	.GBDM (12 pieces)
Group C charge	.GRPC
Group C destructive electrical samples	.GCDE (12 pieces)
Group C destructive mechanical samples	.GCDM (6 pieces)
ESA/ESCC	
Lot Validation Testing (subgroup 1) charge	.LVT1
LVT1 destructive samples (environmental)	.L1DE (15 pieces)
LVT1 destructive samples (mechanical)	.L1DM (15 pieces)
Lot Validation Testing (subgroup 2) charge	.LVT2
LVT2 endurance samples (electrical)	.L2D (15 pieces)
Lot Validation Testing (subgroup 3) charge	.LVT3
LVT3 destructive samples (mechanical)	.L3D (5 pieces)

Additional Option Notes:

- 1) All 'Additional Options' are chargeable and must be specified at order stage.
- 2) When Group B,C or LVT is required, additional electrical and mechanical destructive samples must be ordered
- 3) All destructive samples are marked the same as other production parts unless otherwise requested.

Example ordering information:

The following example is for the 1N6309B part with package variant A, JQRS screening, additional Group C conformance testing and a Data pack.

Part Numbers:

1N6309BD2A-JQRS (Include quantity for flight parts)
1N6309BD2A-JQRS.GRPC (chargeable conformance option)
1N6309BD2A-JQRS.GCDE (charge for destructive parts)
1N6309BD2A-JQRS.GCDM (charge for destructive parts)
1N6309BD2A-JQRS.DA (charge for Data pack)

Customers with any specific requirements (e.g. marking or screening) may be supplied with a similar alternative part number (there is maximum 20 character limit to part numbers). Contact Semelab sales with enquiries.

High Reliability and Screening Options Handbook link: http://www.semelab.co.uk/pdf/misc/documents/hirel_and_screening_options.pdf